

RoHS

SSRS:	APPROVAL NO	710-815
	DATE	2024.07.10

ALUMINUM ELECTROLYTIC

CAPACITOR

APPROVAL SHEET

CATALOG TYPE	BXJ SERIES
CATALOG TIPE	
USER PART NO.	
适 用 机 种	
特记事项	Halogen-Free

QINGDAO SAMYOUNG ELECTRONICS CO.,LTD MANAGER OF DEVELOPMENT DEPARTMENT

GONG JANG SUG

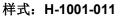


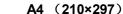
l	JS	Ε	R	A	P	Ρ	R	O	۷	Ά	ιL	:
---	----	---	---	---	---	---	---	---	---	---	----	---

APPROVAL NO.:

SamYoung(Korea): 47,SAGIMAKGOL-RO,JUNGWON-GU,SEONGNAM-SI,GYEONGGI-DO,KOREA

SamYoung(China): No.5 CHANGJIANG ROAD, PINGDU-CITY, SHANDONG-PROVINCE, CHINA







APPROVAL NO.

710-815

ALUMINUM ELECTROLYTIC CAPACITOR

PAGE: 1 OF 7

DATE: 2024.07.10

SPECIFICATIONS

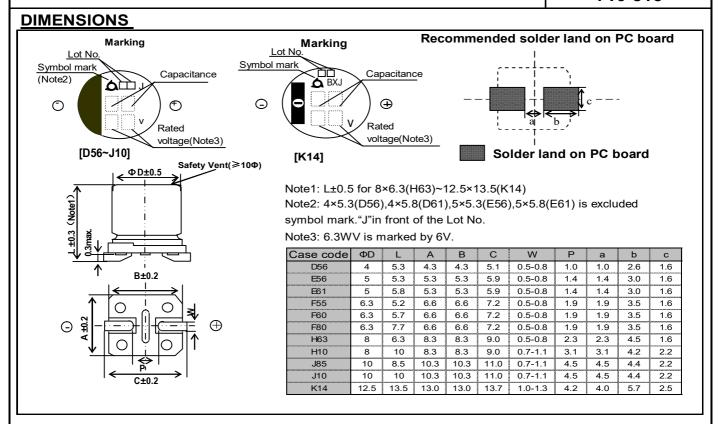
<u> </u>										
Item				Chara	cterist	ics				
Rated Voltage Range	6.3 ~ 50	VDC				63 ~ 100 VDC				
Operating Temperature Range	- 55 ~ + 1	- 55 ~ + 105 ℃					- 40 ^	~ + 10	5℃	
Capacitance Tolerance		±20%(M) (at 20 ℃,12						℃,120Hz)		
	I = 0.01CV(μA) or 3 μA,	which	ever is o						`	,
	Where,I: Max.Leakage co		-	,						
Leakage Current	C: Nominal capa		. ,							
	V: Rated Voltage		•					(at 20 ℃	,2 minutes)
Dissipation Factor								ì		, ,
·	Rated voltage(VDC)		6.3	10	16	25	35~	100		
Tanδ (Max.)	Tanδ (Max.)	().26	0.19	0.16	0.14	0.1	12		
							<u> </u>		(at 12	.0Hz,20℃)
	Rated Voltage (VDC)	6.3	10	16	25	35	50	63	100	
Temperature characteristics	Z(-25°C)/Z(20°C)	3	2	2	2	2	2	3	3	
(Max. Impedance ratio)	Z(-55℃)/Z(20℃)	5	4	4	3	3	3	※4	※4	
	% Z(-40℃)/Z(20℃)								(a	t 120Hz)
	The following specifications shall be satisfied when the capacitors are restored to 20°									
	after the rated voltage is applied with the following conditions.									
	D56~H63,J85: 105℃,2									
Load Life	Capacitance change				≤± 30%			alue		
	ZAAT				% of the					
	TANδ Leakage current				nitial spe cified va		liue			
	The following specification						itors ar	e resto	red to 20	°C
	after exposing them for					•			100 10 20	
	The rated voltage shall					-			nutes.at	least
	24 hours and not more t	•		-					,	
Shelf Life	Capacitance change	D5	6~H63,	J85: 5	≤± 30%	of the in	nitial V	alue		
		H1	0~K14:	≤± 35	% of the	e initial '	Value			
	ΤΑΝδ	: ≤	≤300% c	of the in	nitial spe	cified va	lue			
	Leakage current	: <	€The init	ial spe	cified va	lue				
Others	Satisfies characteristic I	KS C	IEC 603	<u>84-4</u>						







APPROVAL NO. 710-815



RATINGS OF BXJ Series

μF		6.3			10			16			25			35			50			63			100	
2.2																D56	10.0	15						
4.7													D56	1.80	85	D56	4.80	20						
4.7																E56	3.00	55						
							D56	1.8	85	D56	1.80	85	D56	1.80	85	E61	2.00	50	F60	4.50	48	F80	3.00	55
10																						H63	1.80	85
										E56	1.80	85	E56	0.80	155	F60	1.20	120				J85	1.35	100
				D56	1.80	85	D56	1.80	85	E56	0.80	155	E56	0.80	155	F60	1.20	120	F80	3.00	55	H10	1.50	160
22													E61	0.70	160				H63	1.50	100			
							E56	0.80	155	E61	0.70	160	F55	0.55	220				H10	1.00	200			
33	D56	1.80	85	D61	1.35	90	E61	0.70	160	F60	0.36	240	F60	0.36	240	F80	0.90	150	H10	1.00	200	J10	0.60	330
33				E56	0.80	155	F60	0.36	240	F55	0.55	220							J85	0.95	205			
	D61	1.35	90	E61	0.70	160	E61	0.7	160	F55	0.55	220	F60	0.36	240	F80	0.90	150	H10	1.00	200	K14	0.40	400
47							F55	0.80	156	F60	0.6	240				H63	0.75	200						
	E56	0.80	155	F60	0.36	240	F60	0.36	240															
56													•			H10	0.78	210						
68	E61	0.70	160	E61	0.7	160	F60	0.36	240	F60	0.36	240	F80	0.34	280	H10	0.44	300	J10	0.50	350	K14	0.40	400
08	F60	0.36	240	F60	0.36	240				F80	0.34	280	H63	0.26	300									
	E61	0.70	160	F60	0.36	240	F60	0.36	240	F80	0.34	280	H10	0.16	600	H10	0.44	300	J10	0.50	350	K14	0.40	400
100										H63	0.26	300	J85	0.15	620	J85	0.40	315						
	F60	0.36	240							H10	0.16	600	J10	0.08	850	J10	0.25	500						
220	F60	0.36	240	F80	0.34	280	F80	0.34	280	J85	0.15	620	H10	0.16	600	J10	0.25	500						
220										H10	0.16	600	J10	0.08	850									
330	F80	0.34	280	H10	0.16	600	H10	0.16	600	J10	0.08	850	J10	0.08	850	K14	0.11	650						
330							J85	0.15	620	H10	0.16	600												
390													J10	0.08	850									
470	H10	0.16	600	H10	0.16	600	H10	0.16	600	J10	0.08	850	K14	0.06	1100									
470	J85	0.15	620	J85	0.15	620	J10	0.08	850															
1000	H10	0.16	600	J10	0.08	850	K14	0.06	1100	K14	0.06	1100	***************************************											
1500	J10	0.08	850	K14	0.06	1100																		
2200	K14	0.06	1100	K14	0.06	1100							***************************************											
	\uparrow	\uparrow	1		d ripp endan						100kH	lz)												

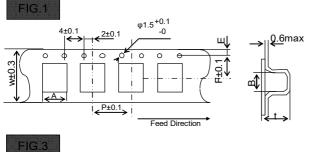


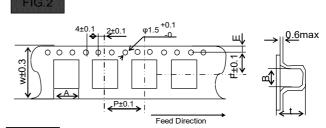
Case code

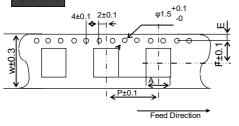
APPROVAL NO.

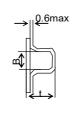
710-815

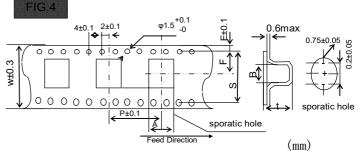
TAPING DIMENSIONS





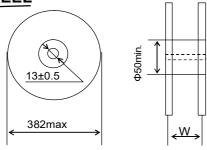






									(111111)
Case code	Fig	W	Α	В	F	E	Р	t	S
ФЗ (В55)	1	12	3.5±0.2	3.5±0.2	5.5	1.75±0.1	8	5.9±0.2	_
Ф4 (D55, D56, D60)	1	12	4.7±0.2	4.7±0.2	5.5	1.75±0.1	8	5.7±0.2 (D55, D56)	_
Ф5 (Е55, Е56, Е60)	2	12	5.7±0.2	5.7±0.2	5.5	1.75±0.1	12	5./±0.2 (E55, E56)	_
Ф6.3 (F55, F56, F60)	2	16	7.0±0.2	7.0±0.2	7.5	1.75±0.1	12	5.7±0.3 (F55, F56)	_
Ф6.3×8L (F80)	2	16	7.0±0.2	7.0±0.2	7.5	1.75±0.1	12	8.2±0.2	<u>—</u>
Ф8×6L (H63)	2	16	8.7±0.2	8.7±0.2	7.5	1.75±0.1	12	6.8±0.2	_
Ф8×6.7L (H70)	2	24	8.7±0.2	8.7±0.2	11.5	1.75±0.1	12	7.3±0.2	_
Ф8×10L (H10)	3	24	8.7±0.2	8.7±0.2	11.5	1.75±0.1	16	11.0±0.2	_
Ф8×11.5L (H12)	3	24	8.7±0.2	8.7±0.2	11.5	1.75±0.1	16	12.3±0.2	_
Ф10×10L (J10)	3	24	10.7±0.2	10.7±0.2	11.5	1.75±0.1	16	11.0±0.2	
ф 10×12.2L (Ў12)	3	24	10.7±0.2	10.7±0.2	11.5	1.75±0.1	16	13.0±0.2	_
Ф12.5×13.5L (K14)	4	32	13.4±0.2	13.4±0.2	14.5	1.75±0.1	24	14.0±0.2	28.4±0.1

REEL

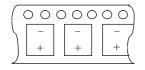


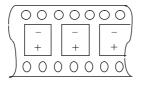
QUANTITY PER REEL

Case code	W (mm)	Q'ty (pcs/reel)	Q'ty (pcs/box)
Ф3 (В55)	14	2,000	20,000
Ф4 (D55, D56, D60)	14	2,000	20,000
Ф5 (E55, E56, E60)	14	1,000	10,000
Ф6.3 (F55, F56, F60)	18	1,000	10,000
Ф6.3×8L (F80)	18	900	9,000
Ф8×6L (H63)	18	1,000	10,000
Ф8×6.7L (H70)	26	1,000	6,000
Ф8×10L (H10)	26	500	3,000
Ф8×11.5L (H12)	26	400	2,400
Ф10×10L (J10)	26	500	3,000
ф 10×12.2L (J12)	26	400	2,400
Ф12.5×13.5L (K14)	34	200	1,000

ORIENTATION OF POLARITY

Feed Direction





[ϕ 3 ~ ϕ 10]

[φ12.5]

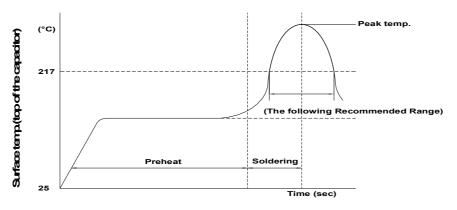


APPROVAL NO: 710-815

RECOMMENDED Pb-FREE REFLOW SOLDERING CONDITIONS

The following conditions are recommended for air or infrared reflow soldering of the surface mount capacitors onto a glass epoxy circuit board of 90X50X0.8mm(with resist)by cream solder (eutectic solder).

The temperatures shown are the surface temperature values of the top of the capacitor.



TEMPERATURE PROFILE

CASE CODE	Time of Preheat temp. (from 150 ℃ to 200℃)	Time to be maintained above 217℃	Time to be maintained above 230℃	Peak Temp. (℃)	Reflow Cycle
B55,D55,D56,E55,E56 ,F55,F56,F60,F80,H63 ,H10,J85,J10,K14		60~70 Sec	20~30 Sec	250(10Sec ↓)	1 TIME

PRECAUTIONS TO USERS

Soldering method

The capacitors of Alchip series have no capability to withstand such dip or wave soldering as totally immerses a components to the capacitors because the following makes a difference in the stress to the capacitors. If any other reflow soldering conditions are applied, please consult us.

- 1.Location of components. (The edge sides of a PC board increases its temperature more than the center does)
- 2. Population of components. The less the component population is, the more the temperature is increased.
- 3. Material of printed circuit board. As a ceramic board needs heating up more than a glass epoxy board to reach the same board temperature, the capacitors may be damaged.
- 4. Thickness of PC board. A thick PC board needs heating up more than a thin board. It may damage the capacitors.
- 5. Size of PC board. A larger PC board needs heating up more than a small board, and it may damage the capacitors.
- 6.Location of infrared ray lamps. On IR reflow as well as hot plate reflow, heating only the revese side of the PC board will reduce a stress to the capacitors.

Rework of soldering

Avoid reflow soldering more than once by reflow. Use a soldering iron for rework.of solder, and do not exceed an iron tip temperature of 300° C and a max. exposure time of 5 seconds.

Mechanical stress

Do not lift up or push the capacitor after soldering. Avoid curvature of the PC board. These may damage the capacitor.

inadequately dried after a washing process, the capacitors will keep suffering from a residual solvent for long periods of time, and will be corroded while in service.

Coating on assembly board

- 1.Before coating, evaporate cleaning solvents from the assembly board
- 2.Before conformal coating, using a buffer pre-coat which does not contain chloride is recommanded to reduce stress to the capacitors.

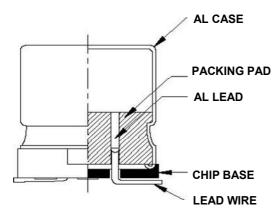
Molding with resin

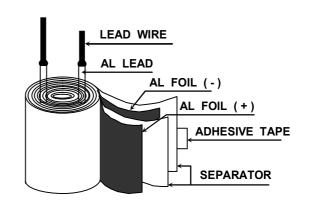
Inner pressure of a capacitor slowly increases over the service life of the capacitor with gas being produced by internal chemical reaction. If the end seal of the capacitor is completely be in danger. Also if the resin contains a large amount of chlorine ion, it will penetrate into the end seal, get into the inside element of the capacitor, and damage the capacitor while in service.

The Precautions to users for Aluminum Electrolytic Capacitors shall be applied.

APPROVAL NO: 710-815

STRUCTURE AND MATERIALS





MINIATURE SIZED TYPE CAPACITORS COMPONENT

PART NAME	MATERIALS	VENDER			
		KISTRON	(KOREA/CHINA)		
LEAD WIRE	TINNED COPPER - PLY WIRE(PB-FREE)	коноки	(JAPAN/CHINA)		
		NANTONG HONGYANG	(CHINA)		
		KISTRON	(KOREA/CHINA)		
AL LEAD	ALUMINUM 99.92%	коноки	(JAPAN/CHINA)		
		NANTONG HUIFENG	(CHINA)		
PACKING PAD	SYNTHETIC RUBBER	SUNG NAM	(KOREA/CHINA)		
PACKING PAD	STNINETIC RUBBER	ccw	(CHINA)		
		BASE	(KODEA)		
CUID DACE	DDA / DOLV DUTUAL AMIDE \	ZICVISION	(KOREA)		
CHIP BASE	PPA (POLY PHTHAL AMIDE)	SANKYO TOHOKU	(JAPAN)		
		VIVID	(CHINA)		
AL CASE	COATED ALUMINUM	D.N TECH/HA NAM	(KOREA)		
AL CASE	COATED ALOMINUM	LINAN AOXING	(CHINA)		
		SAM YOUNG	(KOREA)		
AL FOIL (+)	FORMED ALUMINUM 99.9% OVER	K.D.K/JCC/MATSUSHITA	(JAPAN)		
AL FOIL (+)	FORMED ALUMINUM 99.9% OVER	BECROMAL	(ITALY)		
		HEC/NANTONG	(CHINA)		
		K.D.K	(JAPAN)		
AL FOIL (-)	ETCHED ALUMINUM 98% OVER	K-JCC	(KOREA)		
		ELECON/WU JIANG FEILO	(CHINA)		
SEPARATOR	INSULATION PAPER	N.K.K	(JAPAN)		
SEFARATUR	INSULATION PAPER	KAN	(CHINA)		
ADUESIVE TARE	POLYPHENYLENE SULFIDE OR POLY IMIDE FILM	DAEIL/SWECO	(KOREA)		
ADDESIVE TAPE	POLIPHENTLENE SULFIDE OR POLITIMIDE FILM	NITTO/NICHIBAN	(JAPAN)		

When using aluminum electrolytic capacitors, pay strict attention to the following:

1. Electrolytic capacitors for DC application require polarization.

Confirm the polarity. If used in reversed polarity, the circuit life may be shortened or the capacitor may be damaged. For use on circuits whose polarity is occasionally reversed, or whose polarity is unknown, use bi-polarized capacitors (BP-series). Also, note that the electrolytic capacitor cannot be used for AC application.

2. Do not apply a voltage exceeding the capacitor's voltage rating.

If a voltage execeeding the capacitor's voltage rating is applied, the capacitor may be damaged as leakage current increases. When using the capacitor with AC voltage superimposed on DC voltage, care must be exercised that the peak value of AC voltage does not exceed the rated voltage.

3. Do not allow excessive ripple current to pass.

Use the electrolytic capacitor at current values within the permissible ripple range. If the ripple current exceeds the specified value, request capacitors for high ripple current applications.

4. Ascertain the operating temperature range.

Use the electrolytic capacitors according to the specified operating temperature range. Usage at room temperature will ensure longer life.

5. The electrolytic capacitor is not suitable for circuits in which charge and discharge are frequently repeated.

If used in circuits in which charge and discharge are frequently repeated, the capacitance value may drop, or the capacitor may be damaged. Please consult our engineering department for assistance in these applications.

6. Apply voltage treatment to the electrolytic capacitor which has been allowed to stand for a long time.

If the electrolytic capacitor is allowed to stand for a long time, its withstand voltage is liable to drop, resulting in increased leakage current. If the rated voltage is applied to such a product, a large leakage current occurs and this generates internal heat, which damaged the capacitor. If the electrolytic capacitor is allowed to stand for a long time, therefore, use it after giving voltage treatment (Note 1). (However, no voltage treatment is required if the electrolytic capacitor is allowed to stand for less than 2 or 3 years at normal temperature.)

7. Be careful of temperature and time when soldering.

When soldering a printed circuit board with various, components, care must be taken that the soldering temperature is not too high and that the dipping time is not too long. Otherwise, there will be adverse effects on the electrical characteristics and insulation sleeve of electrolytic capacitors in the case of small-sized electrolytic capacitors, nothing abnormal will occur if dipping is performed at less than 260 °C for less than 10 seconds.

8. Do not place a soldering iron on the body of the capacitor.

The electrolytic capacitor is covered with a vinyl sleeve. If the soldering iron comes in contact with the electrolytic capacitor body during wiring, damage to the vinyl sleeve and/or case may result in defective insulation, or improper protection of the capacitor element.

9. Cleaning circuit boards after soldering.

Some solvents have adverse effects on capacitors.

Please refer to the next page.

10.Do not apply excessive force to the lead wires or terminals.

If excessive force is applied to the lead wires and terminals, they may be broken or their connections with the internal elements may be affected. (For strength of terminals, refer to KS C IEC 60384-4(JIS C5101-1, JIS C5101-4)

11. Care should be used in selecting a storage area.

If electrolytic capacitors are exposed to high temperatures caused by such things as direct sunlight, the life of the capacitor may be adversely affected. Storage in a high humidity atmosphere may affect the solderability of lead wires and terminals.

12.Surge voltage.

The surge voltage rating is the maximum DC over-voltage to which the capacitor may be subjected for short periods not exceeding approximately 30 seconds at infrequent intervals of not more than six minutes. According to KS C IEC 60384-4, the test shall be conducted 1000 cycles at room temperature for the capacitors of characteristic KS C IEC 60384-4 or at the maximum operating temperature for the capacitors of characteristics B and C of KS C IEC 60384-4 with voltage applied through a series resistance of 1000 ohms without discharge. The electrical characteristics of the capacitor after the test are specified in KS C IEC 60384-4. Unless otherwise specified, the rated surge voltage are as follows:

Rated Voltage(V) 16 63 315 350 400 420 450 500 10 35 50 80 100 120 160 200 250 550 Rated Surge Voltage(V) 8 20 32 44 63 79 100 150 200 l

Note 1 Voltage treatment ... Voltage treatment shall be performed by increasing voltage up to the capacitor's voltage rating gradually while lowering the leakage current. In this case, the impressed voltage shall be in the range where the leakage current of the electrolytic capacitor is less than specified value. Meanwhile, the voltage treatment time may be effectively shortened if the ambient temperature is increased (within the operating temperature range).

Note 2 For methods of testing, refer to KS C IEC 60384-4, (JIS C 5101-1, JIS C 5101-4)



CLEANING CONDITIONS

Aluminum electrolytic capacitors that have been exposed to halogenated hydrocarbon cleaning and defluxing solvents are susceptible to attack by these solvents. This exposure can result in solvent penetration into the capacitors, leading to internal corrosion and potential failure.

Common type of halogenated cleaning agents are listed below.

Chemical Name	Structural Formula	Representatice Brand Name
Trichlorotrifluoroethane	C ₂ Cl ₃ F ₃	Freon TF,Daiflon S-3
Fluorotrichloromethane	CCl₃F	Freon-11,Daiflon S-1
1,1,1-Trichloroethane	F2H3Cl3	Chloroethane
Trichloroethylene	C2HCl3	Trichiene
Methyl Chloride	CH₃CI	MC

We would like to recommend you the below cleaning materials for your stable cleaning condition taking the place of previous materials.

Olsopropyl Alcohol(IPA) or Water

Cleaning method: One of immersion, ultrasonic or vapor cleaning.

Maximum cleaning time: 5 minutes(Chip type: 2 minutes)

※Do not use AK225AES

Aluminum electrolytic capacitors are easily affected by halogen ions, particularly by chloride ions. Excessive amounts of halogen ions, if happened to enter the inside of the capacitors, will give corrosion accidents-rapid capacitance drop and vent open. The extent of corrosion accidents varies with kinds of electrolytes and seal-materials. Therefore, the prevention of halogen ion contamination is the most improtant check point for quality control in our procuction lines. At present, halogenated hydrocarbon-contained organic solvents such as Trichloroethylene, 1,1,1-Trichloroethane, and Freon are used to remove flux from circuit boards.

If electroytic capacitors are cleaned with such solvents, they may gradually penetrate the seal portion and cause the eosion. When using latex-based adhesive on the capacitors rubber end seal for adhesion to a PCB, corrosion may occur depending on the kind of solvent in the adhesive. Select an adhesive as an organic solvent with dissolved polymer that is not halogenated hydrocarbon. Hot air drying is required for eliminating the solvent between the product and the PCB at $50^{\circ}\text{C} \sim 80^{\circ}\text{C}$ after coating.

Followings are the penetration path of the halogenated solvent.

- ① Penetration between the rubber and the aluminum case
- 2 Penetration between the rubber and the lead wire
- ③ Penetration through the rubber

The inside of the capacitors, the mechanism of corrosion of aluminum electrolytic capacitors by halogen ions can be explained as follows:

Halides(RX) are absorbed and diffused into the seal portion. The halides then enter the inside of the capacitors and contact with the electrolyte of the capacitors. Where by halogen ions are made free by a hydrolysis with water in the electrolyte:

$$RX + H_2O \rightarrow ROH + H^{\dagger} + X^{-}$$

The halogen ions (X⁻) react with the dielectric substance(Al₂O₃) of aluminum electrolytic capacitors:

$$Al_2O_3 + 6H^+ + 6X^- \rightarrow 2ALX_3 + 3H_2O$$

AIX₃ is dissociated with water:

$$ALX_3 + 3H_2O \rightarrow AL (OH)_3 + 3H^{+} + 3X^{-}$$

****MANUFACTURING SITE**

- SamYoung Electronics Co., Ltd. (Korea/China)

